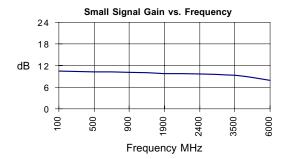




Product Description

Stanford Microdevices' SGA-2163 is a high performance cascadeable 50-ohm amplifier designed for operation from a 2.2-volt supply. This RFIC uses the latest Silicon Germanium Heterostructure Bipolar Transistor (SiGe HBT) process featuring 1 micron emitters with F_T up to 50 GHz.

This circuit uses a darlington pair topology with resistive feedback for broadband performance as well as stability over its entire temperature range. Internally matched to 50 ohm impedance, the SGA-2163 requires only DC blocking and bypass capacitors for external components.



SGA-2163

DC-5000 MHz Silicon Germanium HBT Cascadeable Gain Block



Product Features

- DC-5000 MHz Operation
- 2.2V Single Voltage Supply
- High Output Intercept: +20dBm typ. at 850 MHz
- Low Power Consumption: 20mA
- Low Bias Operation: Can operate with 2V supply

Applications

- Broadband Gain Blocks
- Cordless Phones
- IF/ RF Buffer Amplifier
- Drivers for CATV Amplifiers

| Symbol | Parameters: Test Conditions: Z ₀ = 50 Ohms, Id = 20 mA, T = 25°C | | Units | Min. | Тур. | Max. |
|------------------|--|---|----------------|------|----------------------|------|
| P _{1dB} | Output Power at 1dB Compression | f = 850 MHz f = 1950 MHz | dBm dBm | | 7.1 6.2 | |
| S ₂₁ | Small Signal Gain | f = DC - 1000 MHz f = 1000 - 2000 MHz f = 2000 - 5000 MHz | dB dB dB | 9.3 | 10.3 9.9 9.0 | |
| S ₁₂ | Reverse Isolation | f = DC - 1000 MHz f = 1000 - 2000 MHz f = 2000 - 5000 MHz | dB dB dB | | 15.5 15.9 16.8 | |
| S ₁₁ | Input VSWR | f = DC - 2400 MHz f = 2400 - 5000 MHz | - | | 1.2:1 1.2:1 | |
| S ₂₂ | Output VSWR | f = DC - 2400 MHz f = 2400 - 5000 MHz | - | | 1.2:1 1.2:1 | |
| IP ₃ | Third Order Intercept Point Power out per Tone = -10 dBm | f = 850 MHz f = 1950 MHz | dBm dBm | | 20.0 18.9 | |
| NF | Noise Figure | f = DC - 1000 MHz f = 1000 - 2400 MHz | dB dB | | 4.1 4.4 | |
| T _D | Group Delay | f = 1000 MHz | pS | | 84 | |
| V _D | Device Voltage | | V | 1.9 | 2.2 | 2.5 |

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Phone: (800) SMI-MMIC



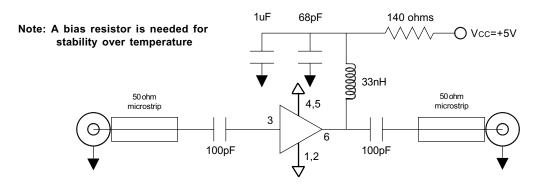


| Specification | | | | | Test |
|-------------------|-----|------|------|------|-----------|
| Parameter | Min | Тур. | Max. | Unit | Condition |
| Device Bias | | | | | T= 25C |
| Operating Voltage | | 2.2 | | V | |
| Operating Current | | 20.0 | | mA | |
| 500 MHz | | | | | T= 25C |
| Gain | | 10.3 | | dB | |
| Noise Figure | | 4.2 | | dB | |
| Output IP3 | | 20.9 | | dBm | |
| Output P1dB | | 7.2 | | dBm | |
| Input Return Loss | | 20.0 | | dB | |
| Isolation | | 15.3 | | dB | |
| 850 MHz | | | | | T= 25C |
| Gain | | 10.2 | | dB | |
| Noise Figure | | 4.1 | | dB | |
| Output IP3 | | 21.0 | | dBm | |
| Output P1dB | | 7.1 | | dBm | |
| Input Return Loss | | 20.6 | | dB | |
| Isolation | | 15.4 | | dB | |
| 1950 MHz | | | | | T= 25C |
| Gain | | 9.8 | | dB | |
| Noise Figure | | 4.4 | | dB | |
| Output IP3 | | 18.9 | | dBm | |
| Output P1dB | | 6.2 | | dBm | |
| Input Return Loss | | 19.4 | | dB | |
| Isolation | | 16.1 | | dB | |
| 2400 MHz | | | | | T= 25C |
| Gain | | 9.6 | | dB | |
| Noise Figure | | 4.8 | | dB | |
| Output IP3 | | 16.9 | | dBm | |
| Output P1dB | | 5.6 | | dBm | |
| Input Return Loss | | 17.6 | | dB | |
| Isolation | | 16.4 | | dB | |

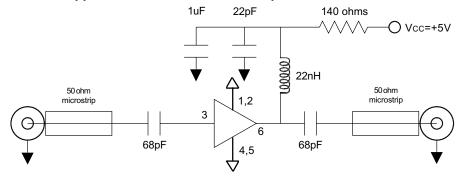


| Pin # | Function | Description | Device Schematic |
|-------|----------|---|------------------|
| 1 | GND | Connection to ground. Use via holes for best performance to reduce lead inductance as close to ground leads as possible. | |
| 2 | GND | Sames as Pin 1 | |
| 3 | RF IN | RF input pin. This pin requires the use of an external DC blocking capacitor chosen for the frequency of operation. | |
| 4 | GND | Sames as Pin 1 | |
| 5 | GND | Sames as Pin 1 | |
| 6 | RF OUT | RF output and bias pin. DC voltage is present on this pin, therefore a DC blocking capacitor is necessary for proper operation. | |

Application Schematic for +5V Operation at 900 MHz

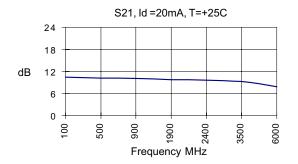


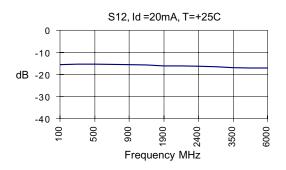
Application Schematic for +5V Operation at 1900 MHz

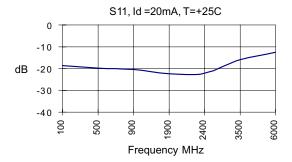


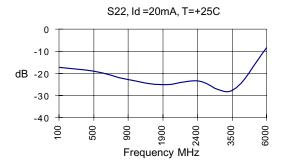


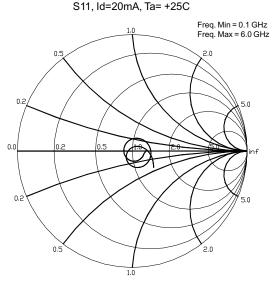


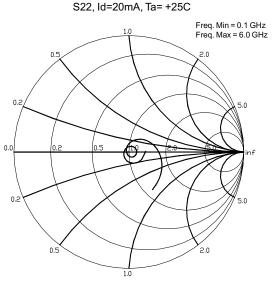






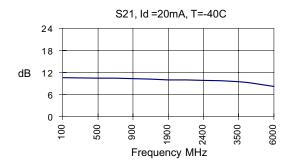


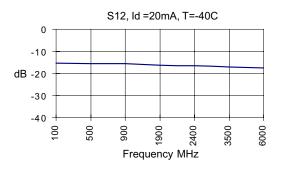


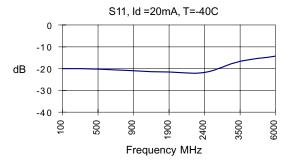


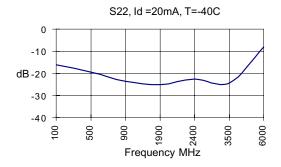


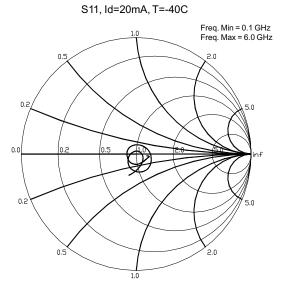


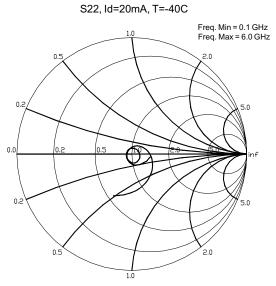






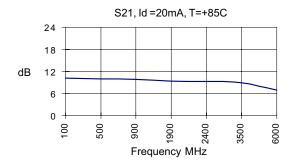


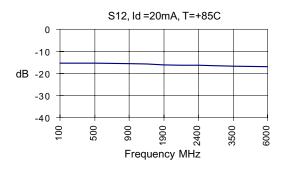


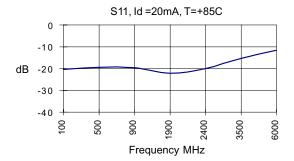


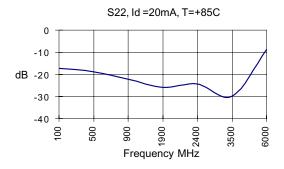


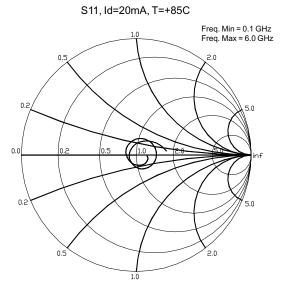


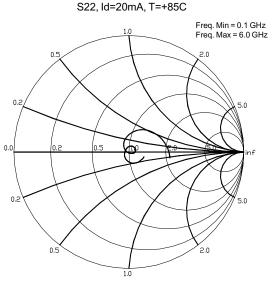
















Absolute Maximum Ratings

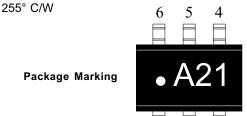
| Parameter | Value | Unit |
|--------------------------------|------------|------|
| Supply Current | 40 | mA |
| Operating Temperature | -40 to +85 | С |
| Maximum Input Power | +2 | dBm |
| Storage Temperature Range | -40 to +85 | C |
| Operating Junction Temperature | +125 | С |

Caution:



Operation of this device above any one of these parameters may cause permanent damage. Appropriate precautions in handling, packaging and testing devices must be observed.

Thermal Resistance (Lead-Junction):



Part Number Ordering Information

| Part Number | Reel Size | Devices/Reel | |
|--------------|-----------|--------------|--|
| SGA-2163-TR1 | 7" | 3000 | |

| Recommended Bias Resistor Values | | | | | |
|----------------------------------|----|-----|------|-----|-----|
| Supply Voltage(Vs) | 3V | 5V | 7.5V | 9V | 12V |
| Rbias (Ohms) | 40 | 140 | 265 | 340 | 490 |

Pad Layout

| Pin Designation | | | | |
|-----------------|--------|--|--|--|
| 1 | GND | | | |
| 2 | GND | | | |
| 3 | RF in | | | |
| 4 | GND | | | |
| 5 | GND | | | |
| 6 | RF out | | | |

Note: Pin 1 is on lower left when you can read package marking

Package Dimensions

